

RJK60S4DPE

600V - 16A - SJ MOS FET
High Speed Power Switching

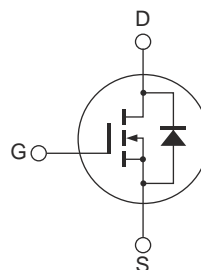
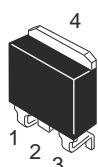
R07DS0733EJ0100
Rev.1.00
Apr 23, 2012

Features

- Superjunction MOSFET
- Low on-resistance
 $R_{DS(on)} = 0.23 \Omega$ typ. (at $I_D = 8 \text{ A}$, $V_{GS} = 10 \text{ V}$, $T_a = 25^\circ\text{C}$)
- High speed switching
 $t_f = 21 \text{ ns}$ typ. (at $I_D = 8 \text{ A}$, $V_{GS} = 10 \text{ V}$, $R_L = 37.5 \Omega$, $R_g = 10 \Omega$, $T_a = 25^\circ\text{C}$)

Outline

RENESAS Package code: PRSS0004AE-B
(Package name: LDKPAK(S)-(1))



1. Gate
2. Drain
3. Source
4. Drain

Absolute Maximum Ratings

($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	600	V
Gate to source voltage	V_{GSS}	+30, -20	V
Drain current	I_D ^{Note1}	16	A
	I_D ^{Note1}	10.1	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	32	A
Body-drain diode reverse drain current	I_{DR} ^{Note1}	16	A
Body-drain diode reverse drain peak current	$I_{DR(pulse)}$ ^{Note1}	32	A
Channel dissipation	P_{ch} ^{Note2}	104.1	W
Channel to case thermal impedance	θ_{ch-c}	1.2	$^\circ\text{C/W}$
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Notes: 1. Limited by T_{ch} max.
2. Value at $T_c = 25^\circ\text{C}$

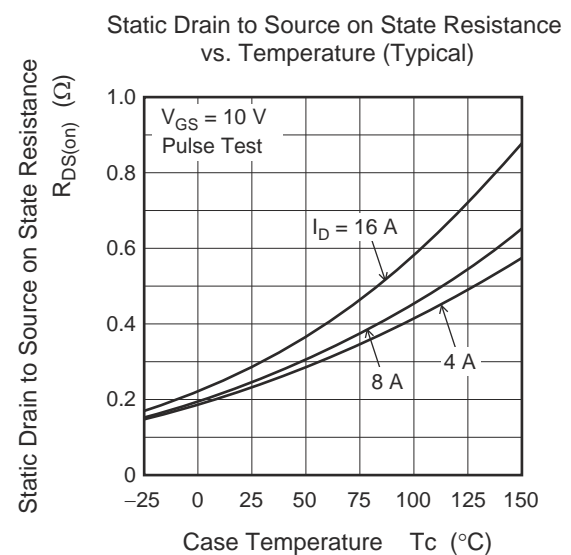
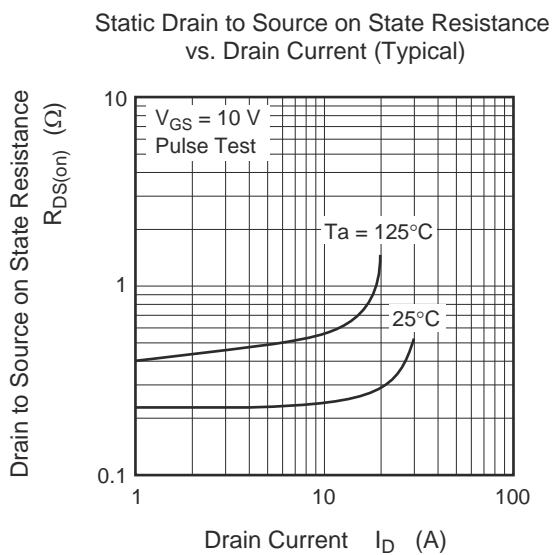
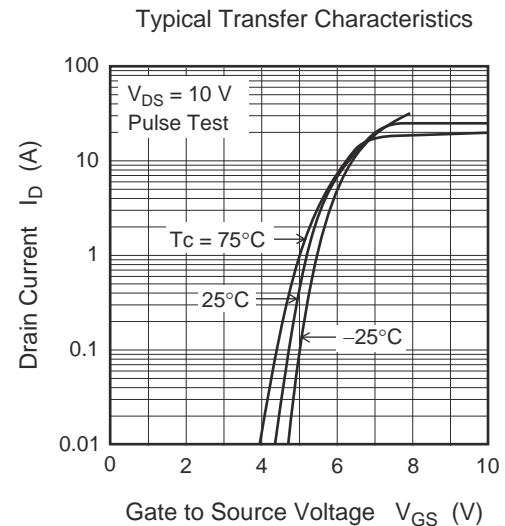
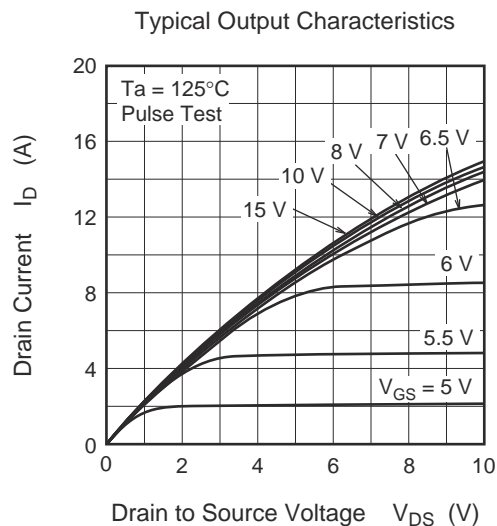
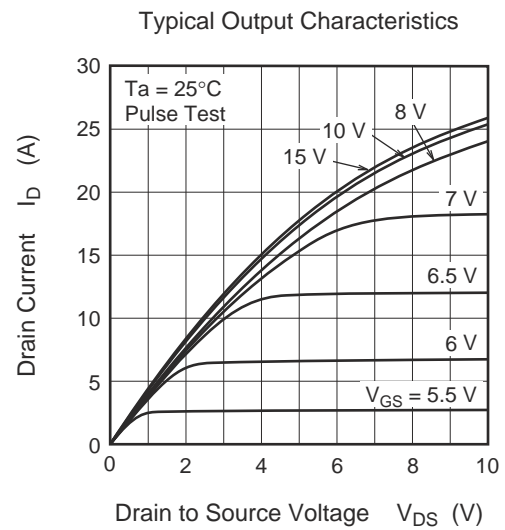
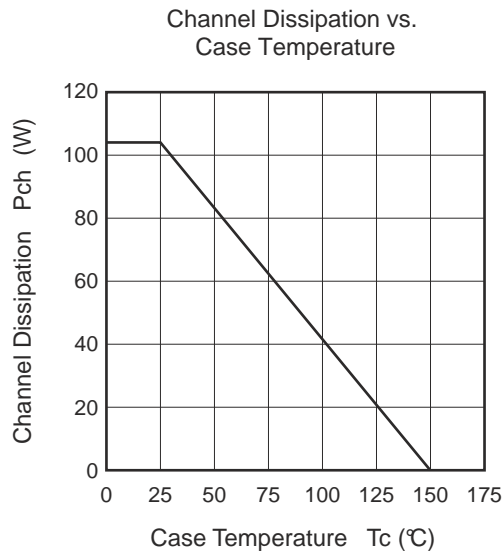
Electrical Characteristics

(Ta = 25°C)

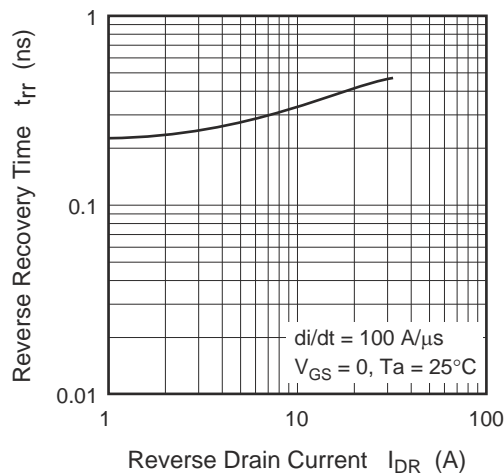
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	600	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	1	mA	$V_{DS} = 600 \text{ V}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 0.1	μA	$V_{GS} = +30\text{V}$, -20 V , $V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	3	—	5	V	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.23	0.29	Ω	$I_D = 8 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{Note3}
	$R_{DS(on)}$	—	0.57	—	Ω	Ta = 150°C $I_D = 8 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{Note3}
Gate resistance	R_g	—	2.5	—	Ω	f = 1 MHz $V_{DS} = 25 \text{ V}$, $V_{GS} = 0$
Input capacitance	C_{iss}	—	1020	—	pF	$V_{DS} = 25 \text{ V}$ $V_{GS} = 0$ f = 100kHz
Output capacitance	C_{oss}	—	1440	—	pF	
Reverse transfer capacitance	C_{rss}	—	5.5	—	pF	
Turn-on delay time	$t_{d(on)}$	—	26	—	ns	$I_D = 8 \text{ A}$ $V_{GS} = 10 \text{ V}$ $R_L = 37.5 \Omega$ $R_g = 10 \Omega$ ^{Note3}
Rise time	t_r	—	22	—	ns	
Turn-off delay time	$t_{d(off)}$	—	44	—	ns	
Fall time	t_f	—	21	—	ns	
Total gate charge	Q_g	—	17.5	—	nC	$V_{DD} = 480 \text{ V}$ $V_{GS} = 10 \text{ V}$ $I_D = 16 \text{ A}$ ^{Note3}
Gate to source charge	Q_{gs}	—	6	—	nC	
Gate to drain charge	Q_{gd}	—	6	—	nC	
Body-drain diode forward voltage	V_{DF}	—	1.0	1.6	V	$I_F = 16 \text{ A}$, $V_{GS} = 0$ ^{Note3}
Body-drain diode reverse recovery time	t_{rr}	—	380	—	ns	$I_F = 16 \text{ A}$ $V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu\text{s}$ ^{Note3}
Body-drain diode reverse recovery current	I_{rr}	—	23	—	A	
Body-drain diode reverse recovery charge	Q_{rr}	—	4.9	—	μC	

Notes: 3. Pulse test

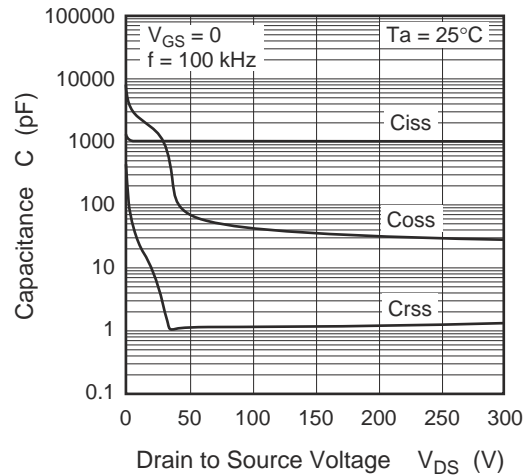
Main Characteristics



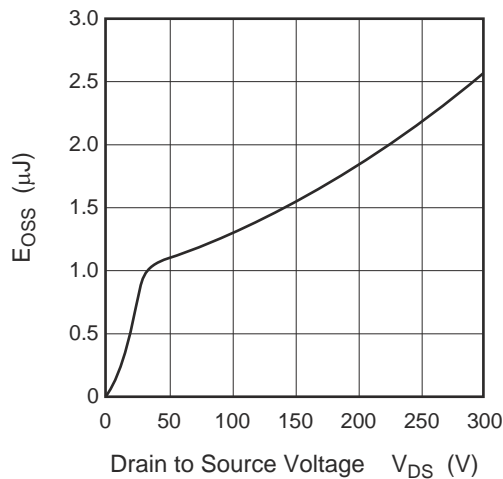
Body-Drain Diode Reverse Recovery Time (Typical)



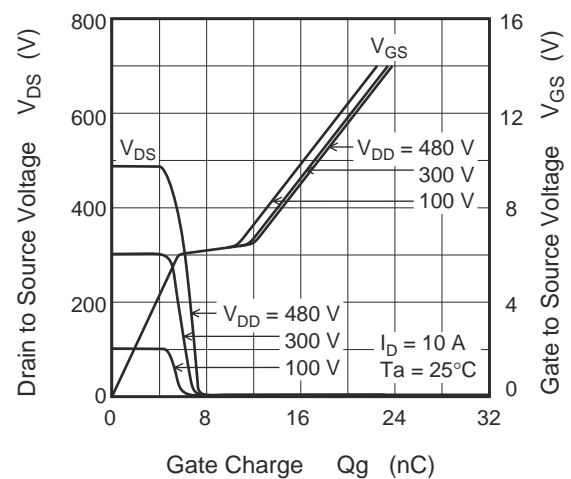
Typical Capacitance vs. Drain to Source Voltage



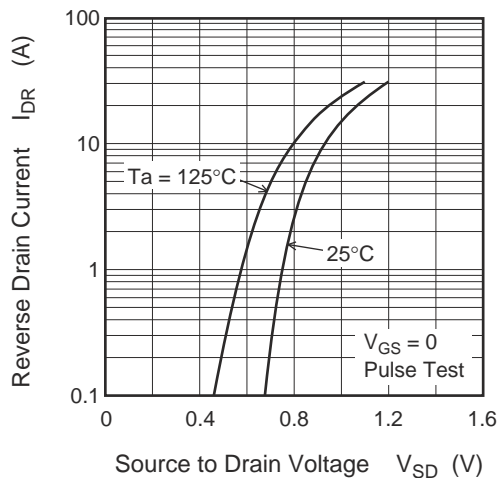
C_{OSS} Stored Energy (Typical)



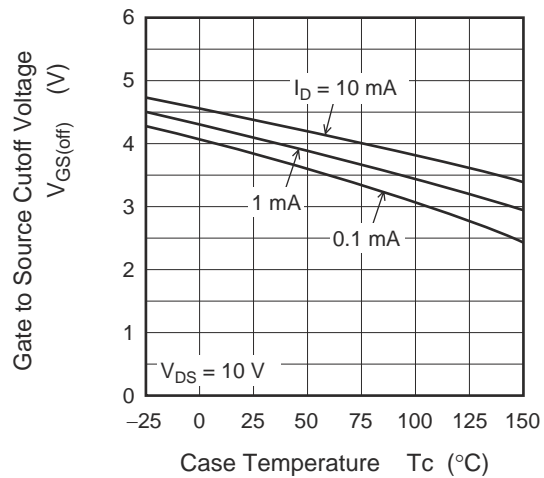
Dynamic Input Characteristics (Typical)



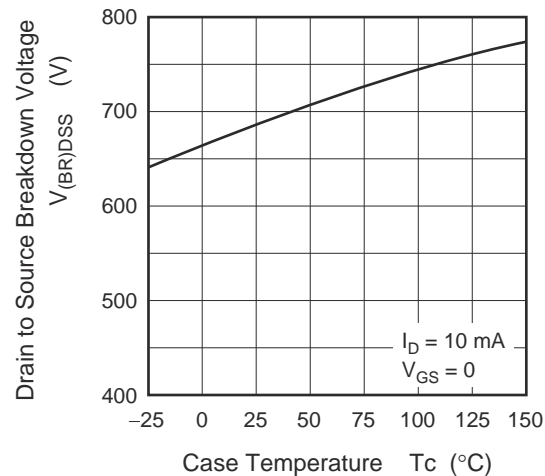
Reverse Drain Current vs. Source to Drain Voltage (Typical)



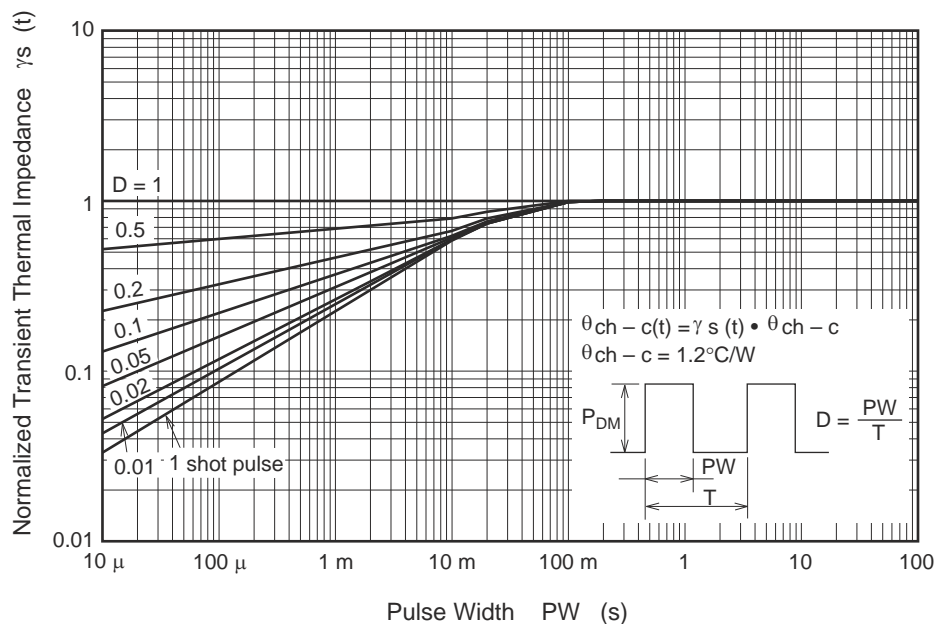
Gate to Source Cutoff Voltage vs. Case Temperature (Typical)



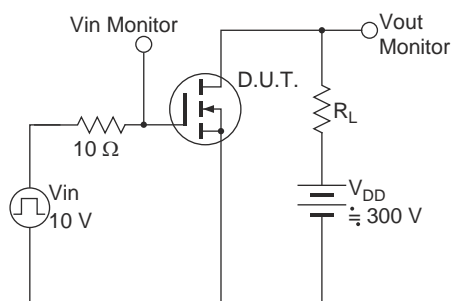
Drain to Source Breakdown Voltage
vs. Case Temperature (Typical)



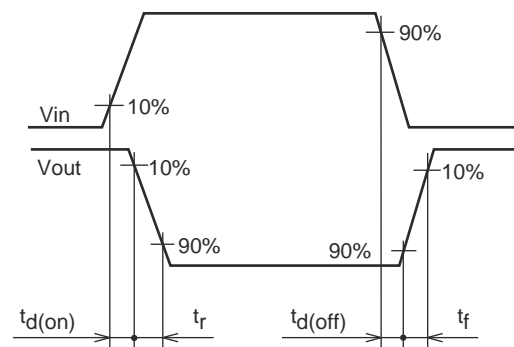
Normalized Transient Thermal Impedance vs. Pulse Width



Switching Time Test Circuit



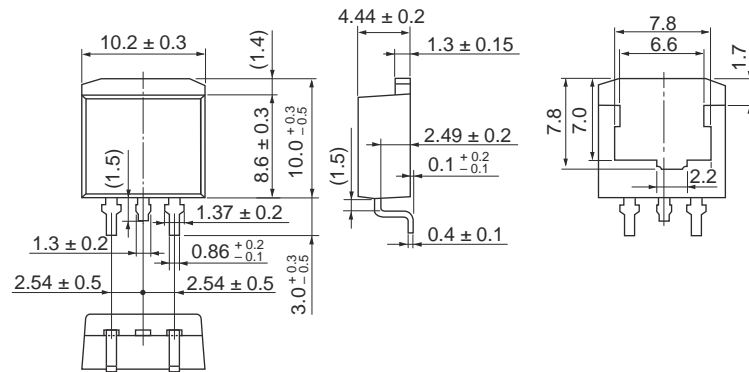
Waveform



Package Dimension

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
LDBAK(S)-(1)	SC-83	PRSS0004AE-B	LDBAK(S)-(1) / LDBAK(S)-(1)V	1.30g

Unit: mm



Ordering Information

Orderable Part No.	Quantity	Shipping Container
RJK60S4DPE-00#J3	1000 pcs	Taping

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Renesas Electronics America Inc.
2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A.
Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited
1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada
Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: +44-1628-585-100, Fax: +44-1628-585-900

Renesas Electronics Europe GmbH
Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
7th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 204, 205, AZIA Center, No.1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China
Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 / -7898

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2886-9318, Fax: +852 2886-9022/9044

Renesas Electronics Taiwan Co., Ltd.
13F, No. 363, Fu Shing North Road, Taipei, Taiwan
Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
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Renesas Electronics Malaysia Sdn.Bhd.
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Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd.
11F., Samik Lavied' or Bldg., 720-2 Yeoksam-Dong, Kangnam-Ku, Seoul 135-080, Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5141